Patent

Customer No.: 31561 Docket No. 9249-US-PA **Application No.: 10/604,791** 

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re application of

Applicant : Lee et al. Application No. Filed

: 10/604,791 : 2003/08/18

For

: SEMICONDUCTOR PACKAGE MODULE AND

MANUFACTURING METHOD THEREOF

Art Unit

: 2811

Examiner

: NGUYEN, CUONG QUANG

# TRANSMITTAL LETTER

002-1-703-872-9306

(Via fax: 3 pages, followed by confirmation copy via courier)

**Assistant Commissioner for Patents** Arlington, Virginia 22202

Dear Sirs,

In response to the Office Action dated June 1, 2004, please find the relevant paper in response to paper No. 20040526. Following the fax transmission, a hard copy via courier will also be forwarded to the Office.

Enclosed documents via courier will include:

Response to Restriction Requirement in (1) pages

Fax confirmation report

Prepaid return postcard

I believe that no fee is incurred. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 9249-US-PA)

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Customer No.: 31561 Docket No. 9249-US-PA Application No.: 10/604,791

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Date: Jul 16, 2004

Belinda Le

Registration No.: 46,863

Please send future correspondence to:

7F. -1, No. 100, Roosevelt Rd.,

Sec. 2, Taipei 100, Taiwan, R.O.C.

Tel: 886-2-2369 2800

Fax: 886-2-2369 7233 / 886-2-2369 7234

P. 01

### TRANSACTION REPORT

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FOR: JCIPO Taiwan

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### RESPONSE TO RESTRICTION REQUIREMENT

ASSISTANT COMISSIONER FOR PATENTS Arlington, VA 22202

Dear Sirs,

In response to the Office Action, mailed on June 1, 2004, Applicant would like to elect Group II, claims 11-23, drawn to a method of making a semiconductor device, classified in class 438, subclass 100+. Please cancel Group I, claims 1-10, drawn to a semiconductor device, classified in class 257, subclass 723 without waiver, prejudice or disclaimer.

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted, JIANQ CHYUN IP Office

Date: Jul 16, 2004

sy: 1 Dec

Registration No.: 46,863

Please send future correspondence to:

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